

Distribution - North America

Solvay Solexis



Golden Electronic / Test Fluids

- ▶ Gross/Fine Leak Detection
- ▶ Thermal Shock



- ▶ Lead Free & Vapor Phase Soldering

Advanced Products & Services

Applied Micro Structures



- ▶ Molecular Vapor Deposition
- ▶ Organic Coatings
- ▶ Metal Oxides Coatings
- ▶ Alternative to CVD & ALD



SemiProbe



- ▶ Wafer / Die Probers
- ▶ Probe & Inspection Systems
- ▶ Flexible configuration platform
- ▶ Manual, Semi-Auto & Auto solutions



NHK Spring Co.



- ▶ Advanced Metal Based PWB's for:
 Automotive, LED Lighting,
 Intelligent Power Modules,
 Inverter Circuits, Converters



Tecnisco Ltd.



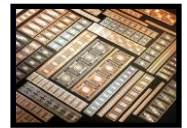
- ▶ Plating/Sputtering/Vapor Deposition
- ▶ Assembling / Bonding
- ▶ Glass Wafer Technology

Packaging Materials & Consumables

Sumitomo Metal Mining Asia Pacific Pte Ltd.



- ▶ Etch / Stamp Lead Frames
- ▶ Plating
- ▶ Laminate Substrates



Sumitomo Metal Mining - MEM



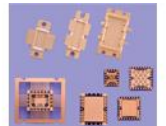
- ▶ Gold Bonding Wire
- ▶ Copper & CuPd Wire



Sumitomo Metal(SMI) Electronic Devices



- ▶ Ceramic Packages
- ▶ Power RF Packages
- ▶ Optical Packages
- ▶ LED Packages



Keaco Inc.



- ▶ Carrier Tape
- ▶ Cover Tape
- ▶ Reels



RGT



- ▶ 6", 8", 12" Wafer Frames
- ▶ Stainless Steel Frames
- ▶ Plastic Frames

Op-Test



- ▶ HB-LED Testing Systems
- ▶ High Speed Optical Test
- ▶ Die Optical Inspection

Electrovac



- ▶ Glass-to-Metal Technology
- ▶ Hermetically Sealed Packages & Sockets



Capital Equipment

Disco USA



- ▶ Wafer Grinding
- ▶ Saw Singulation

- ▶ Laser Singulation
- ▶ Dicing Systems & Blades



DJK Global



- ▶ Semiconductor Inspection Systems
- ▶ Factory Automation Systems
- ▶ Automated Test Handling

▶ Topcon & Hon Technologies Machines

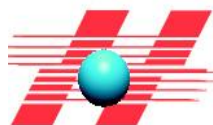


Topcon



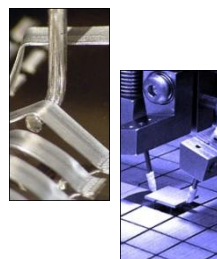
- ▶ Wafer Surface Analyzer
- ▶ Chip Defect Inspection

HON. TECHNOLOGIES



- ▶ Board Level IC Test Handlers
- ▶ Logic IC Test Handlers
- ▶ Flash Card Test Handlers

Royce Instruments



- ▶ Bond Testers:
Wire Pull / Bond Shear / Die Shear
- ▶ Die Sorters: Semi & Automated

Capital Equipment (cont.)

NEU DYNAMICS CORPORATION



- ▶ Precision Molds & Dies
- ▶ Automation Equipment
- ▶ Encapsulation/Insert Molding

▶ Hanmi, FA Systems & K&S Machines



HANMI Semiconductor



- ▶ Assembly Equipment
- ▶ Custom Automation
- ▶ Molding / Marking / Ball Placement / Singulation

FA Systems



FA SYSTEMS AUTOMATION
Your Manufacturing Partner...

- ▶ Laser Marking
- ▶ Inspection Systems
- ▶ Customized Automation Solutions

Kulicke & Soffa



Kulicke & Soffa

- ▶ Manual Wire Bonding Machines
- ▶ Workholders & Accessories

Web Technology, Inc



- ▶ Turret Test Handlers
- ▶ Bubble Testers
- ▶ Centrifuges & Inserts

- ▶ Gross / Fine Leak
Preconditioning Systems

